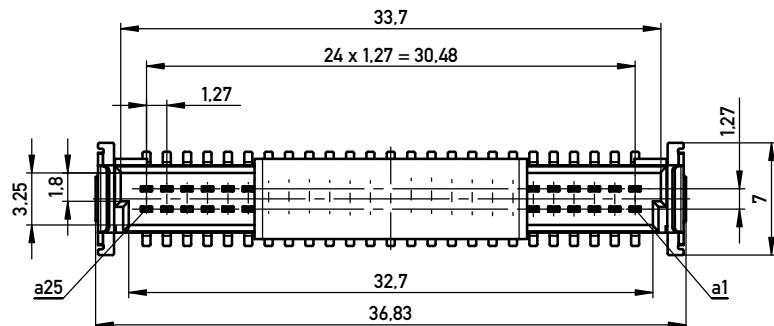
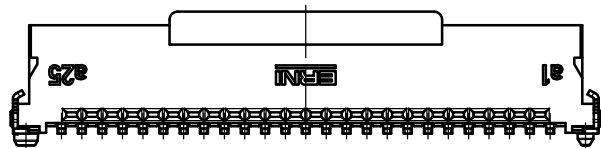
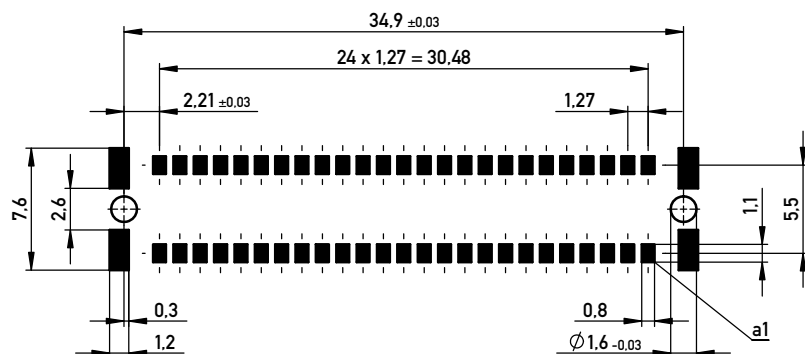




Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



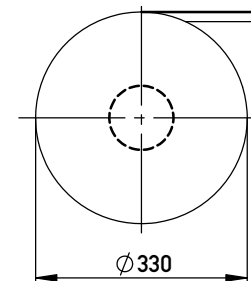
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

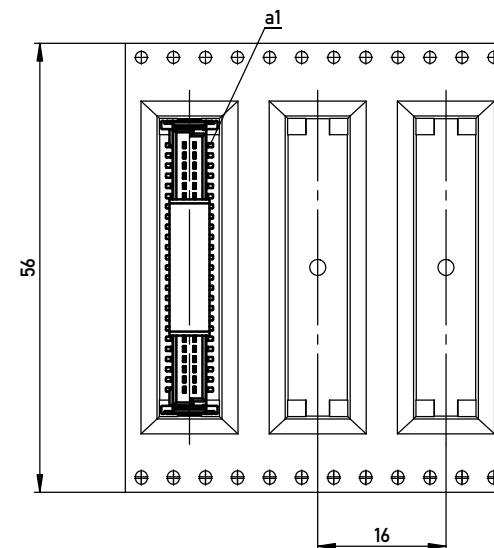
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



BA 8-13 - 8mm Bauhöhe
type 8-13 - Low Profile

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Information:				Tolerances		 All Dimensions in mm		Scale 3:1				
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								Messerl. SMC-Q 50-SMD-BA8-13 <i>Male SMC-Q 50-SMD-type 8-13</i>				
						www.ERNI.com		244838				I
e		30.06.2015						Class SMCQ				A3
Index		Date										

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